

## GaAs MMIC SMT DOUBLE-BALANCED MIXER, 2.5 - 4 GHz

### Typical Applications

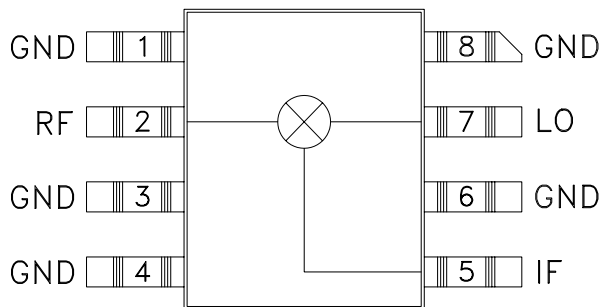
The HMC170C8 is ideal for:

- Microwave Point to Point
- RADAR
- VSAT

### Features

- Conversion Loss: 9.0 dB
- LO to RF Isolation: 45 dB
- Surface Mount
- Small Size, No DC Bias Required

### Functional Diagram



### General Description

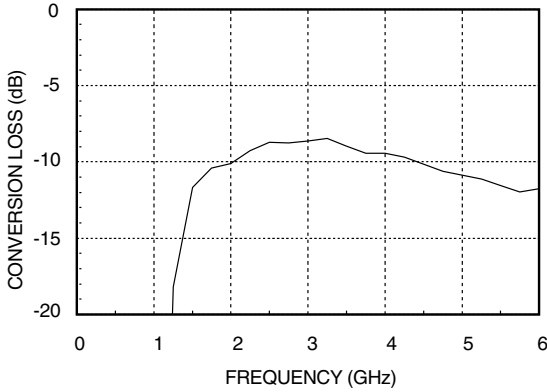
The HMC170C8 is a miniature double-balanced mixer in a non-hermetic ceramic surface mount package that can be used as an upconverter, downconverter or biphase modulator. The device is a passive diode/balun type mixer with high dynamic range. Noise figure is essentially equal to the conversion loss. The mixer can handle larger signal levels than most active mixers due to the high third order intercept. MMIC implementation provides exceptional balance in the circuit resulting in high LO/RF and LO/IF isolations and unit-to-unit consistency. This mixer has applications where small size and surface mount compatibility are important.

### Electrical Specifications, $T_A = +25^\circ C$ , LO Drive = +13 dBm

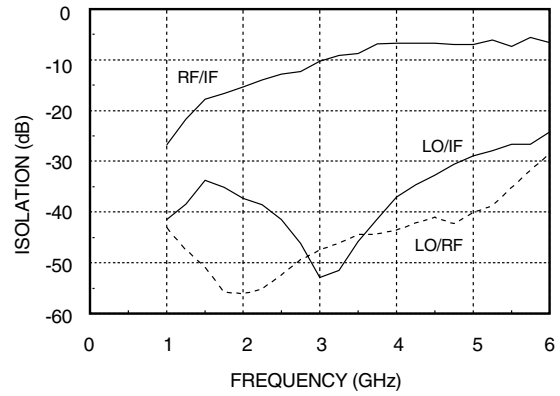
Parameter	Min.	Typ.	Max.	Units
Frequency Range, RF & LO	2.5 - 4.0			GHz
Frequency Range, IF	DC - 2			GHz
Conversion Loss		9	10	dB
Noise Figure (SSB)		9	10	dB
LO to RF Isolation	40	45		dB
LO to IF Isolation	32	36		dB
IP3 (Input)	13	18		dBm
IP2 (Input)	35	40		dBm
1 dB Gain Compression (Input)	7	10		dBm

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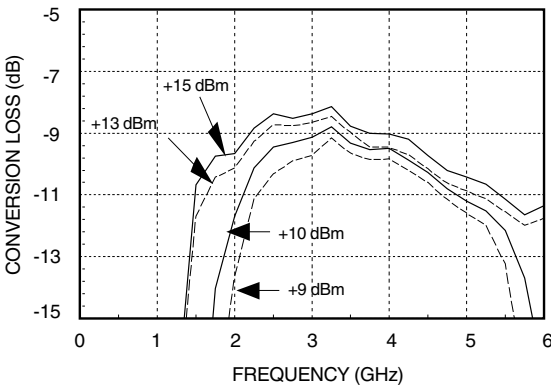
**Conversion Loss**



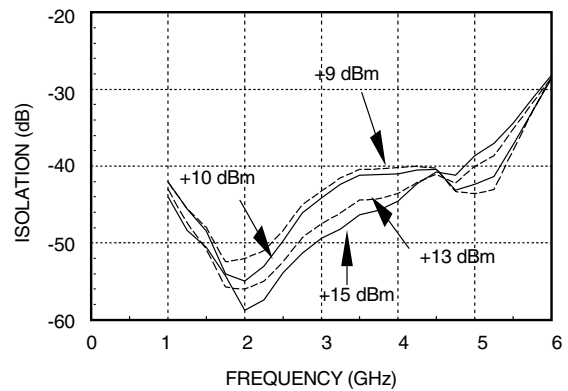
**Isolation**



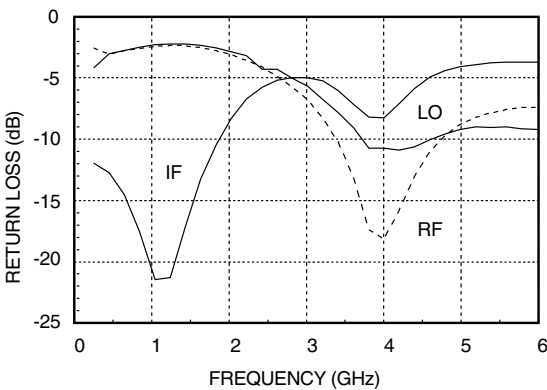
**Conversion Loss vs. LO Drive**



**Isolation vs. LO Drive**



**Return Loss**



**Distortion and 1dB**

**Compression vs. LO Drive Level**

LO Drive (dBm)	Distortion		1 dB Compression (dBm)
	IP3 (dBm)	IP2 (dBm)	
+10	16	38	8
+13	18	40	10
+15	18	40	10

RF (f1) = 3.01 GHz  
RF (f2) = 3.00 GHz  
LO = 3.5 GHz  
RF Level = 0 dBm

S - Parameters for the RF, LO, IF Ports are Available On-Line at [www.hittite.com](http://www.hittite.com)

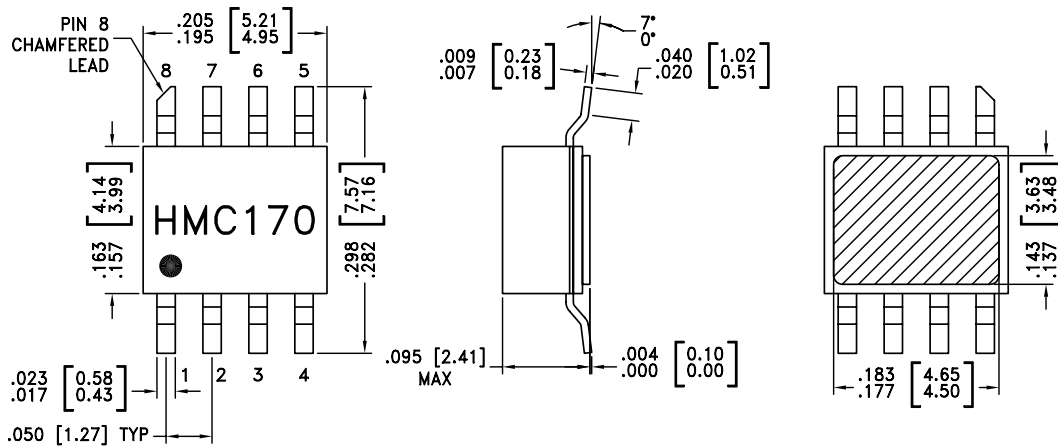
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### Absolute Maximum Ratings

RF / IF Input	+13 dBm
LO Drive	+27 dBm
Storage Temperature	-65 to +150 °C
Operating Temperature	-55 to +85 °C

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### Outline Drawing

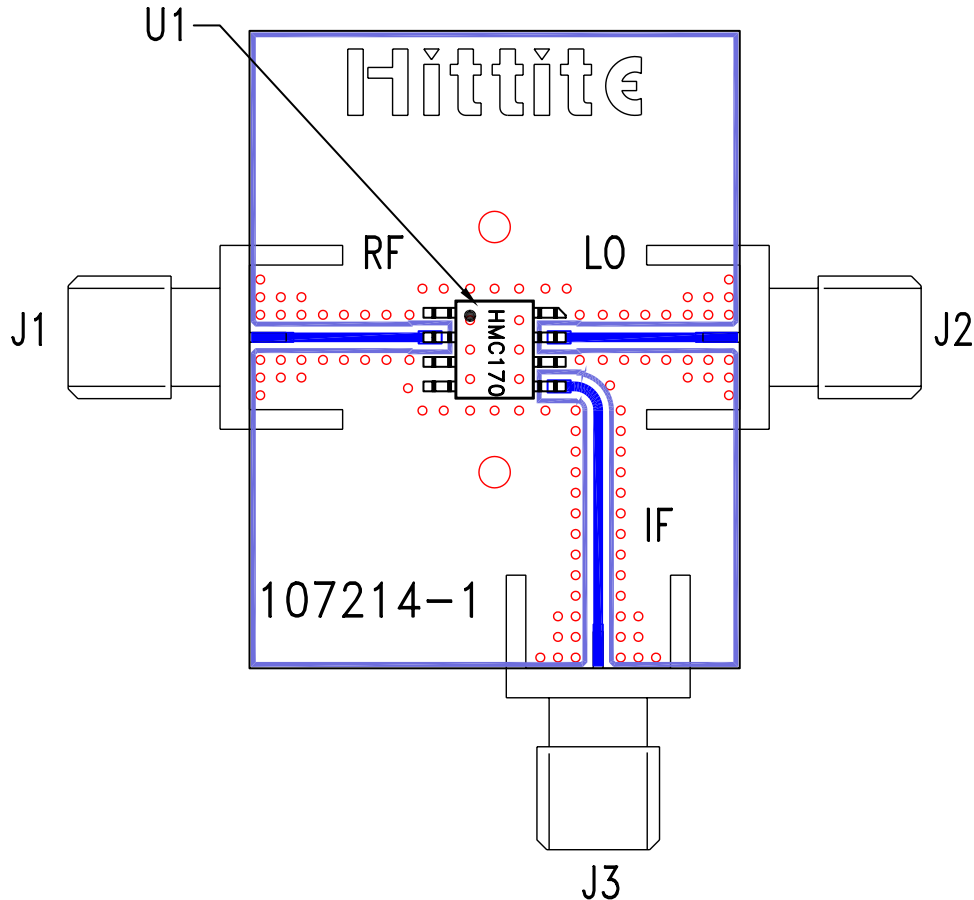


NOTES:

1. PACKAGE BODY MATERIAL: WHITE ALUMINA 92%
2. LEAD, PACKAGE BOTTOM MATERIAL: COPPER
3. PLATING: ELECTROLYTIC GOLD 100-200 MICROINCHES, OVER ELECTROLYTIC NICKEL 100-250 MICROINCHES.
4. DIMENSIONS ARE IN INCHES [MILLIMETERS].
5. PACKAGE LENGTH AND WIDTH DIMENSIONS DO NOT INCLUDE LID SEAL PROTRUSION .005 PER SIDE.
6. ALL GROUND LEADS AND GROUND PADDLE MUST BE SOLDERED TO PCB RF GROUND.

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### Evaluation PCB



### List of Material

Item	Description
J1 - J3	PC Mount SMA RF Connector
U1	HMC170C8 Mixer
PCB*	107214 Evaluation Board
* Circuit Board Material: Rogers 4350	

The circuit board used in the final application should use RF circuit design techniques. Signal lines should have 50 ohm impedance while the package ground leads and exposed paddle should be connected directly to the ground plane similar to that shown. A sufficient number of VIA holes should be used to connect the top and bottom ground planes. The evaluation circuit board shown is available from Hittite upon request.

This datasheet has been download from:

[www.datasheetcatalog.com](http://www.datasheetcatalog.com)

Datasheets for electronics components.